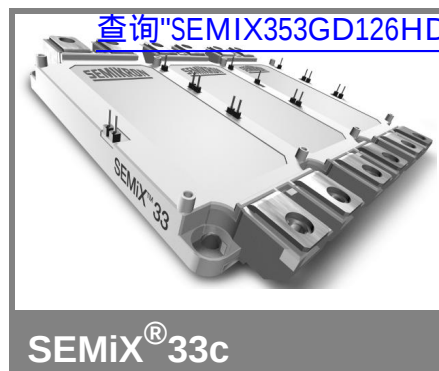


SEMiX 353GD126HDc



Trench IGBT Modules

SEMiX 353GD126HDc

Preliminary Data

Features

- Homogeneous Si
- Trench = Trenchgate technology
- $V_{CE(sat)}$ with positive temperature coefficient
- High short circuit capability

Typical Applications

- AC inverter drives
- UPS
- Electronic Welding

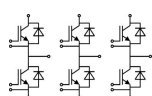
Remarks

- Case temperatur limited to $T_C=125^\circ\text{C}$ max.

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Absolute Maximum Ratings		T _{case} = 25°C, unless otherwise specified		
Symbol	Conditions	Values		Units
IGBT				
V _{CES}	T _j = 25 °C	1200		V
I _C	T _j = 150 °C	T _C = 25 °C	365	A
		T _C = 80 °C	255	A
I _{CRM}	I _{CRM} =2xI _{Cnom}	450		A
V _{GES}		± 20		V
t _{psc}	V _{CC} = 600 V; V _{GE} ≤ 20 V; T _j = 125 °C V _{CES} < 1200 V	10		µs
Inverse Diode				
I _F	T _j = 150 °C	T _C = 25 °C	330	A
		T _C = 80 °C	225	A
I _{FRM}	I _{FRM} =2xI _{Fnom}	450		A
I _{FSM}	t _p = 10 ms; sin. T _j = 25 °C	1700		A
Module				
I _{t(RMS)}		600		A
T _{vj}		- 40 ... + 150		°C
T _{stg}		- 40 ... + 125		°C
V _{isol}	AC, 1 min.	4000		V

Characteristics		T _{case} = 25°C, unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
IGBT					
V _{GE(th)}	V _{GE} = V _{CE} , I _C = 9 mA	5	5,8	6,5	V
I _{CES}	V _{GE} = 0 V, V _{CE} = V _{CES} T _j = 25 °C			0,3	mA
V _{CE0}	T _j = 25 °C T _j = 125 °C		1	1,2	V
			0,9	1,1	V
r _{CE}	V _{GE} = 15 V T _j = 25°C T _j = 125°C		3,1	4,2	mΩ
			4,9	6	mΩ
V _{CE(sat)}	I _{Cnom} = 225 A, V _{GE} = 15 V T _j = 25°C _{chiplev.} T _j = 125°C _{chiplev.}		1,7	2,1	V
			2	2,4	V
C _{ies}	V _{CE} = 25, V _{GE} = 0 V f = 1 MHz		16		nF
C _{oes}			0,84		nF
C _{res}			0,73		nF
Q _G	V _{GE} = -8 ... +15V		1800		nC
t _{d(on)}	R _{Gon} = 2 Ω	V _{CC} = 600V I _{Cnom} = 225A T _j = 125 °C	265		ns
t _r			55		ns
E _{on}	26,5			mJ	
t _{d(off)}	R _{Goff} = 2 Ω		585		ns
t _f			120		ns
E _{off}		32,5		mJ	
R _{th(j-c)}	per IGBT			0,1	K/W



GD

SEMiX 353GD126HDc



Trench IGBT Modules

SEMiX 353GD126HDc

Preliminary Data

Features

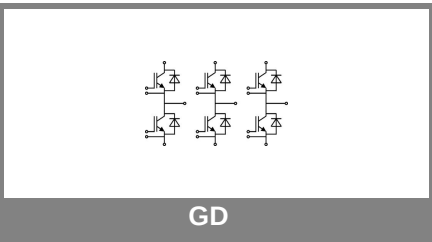
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- UPS
- Electronic Welding

Remarks

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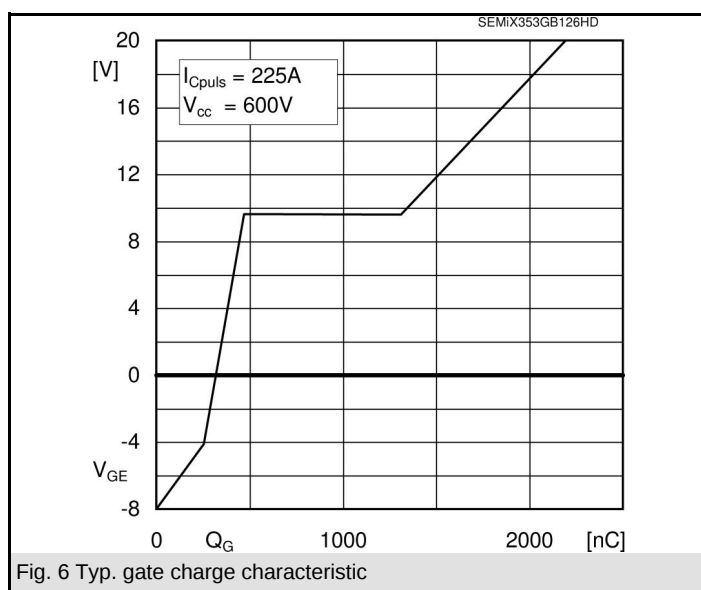
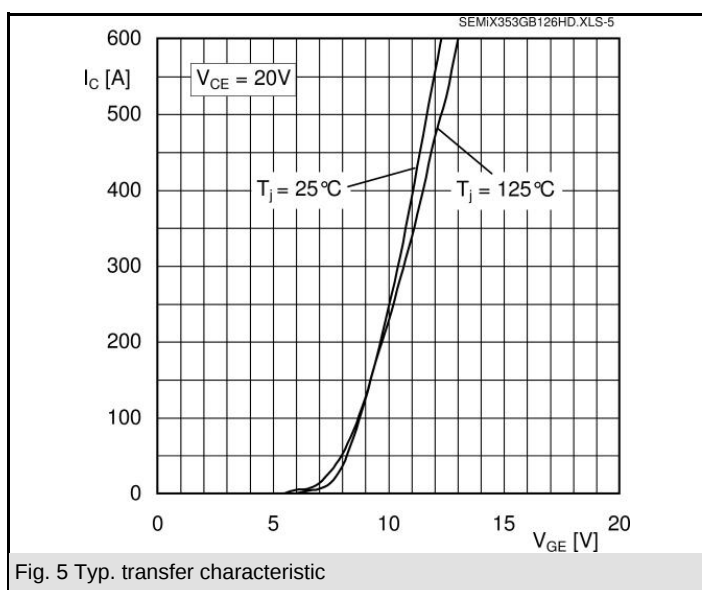
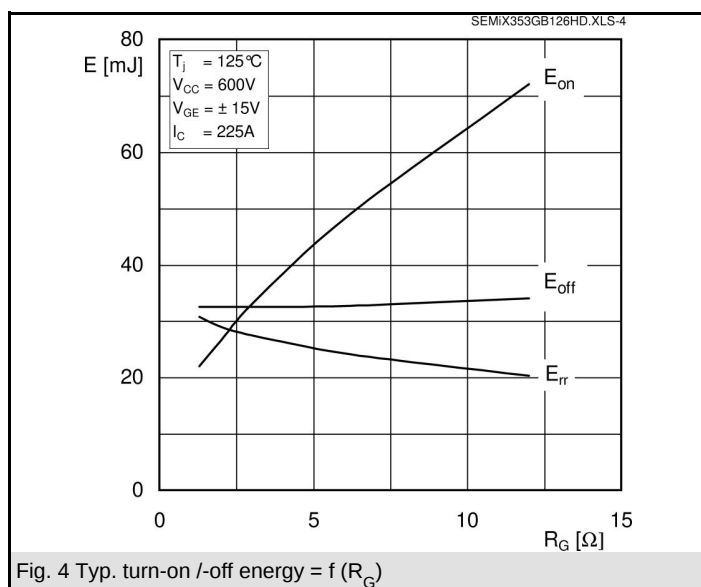
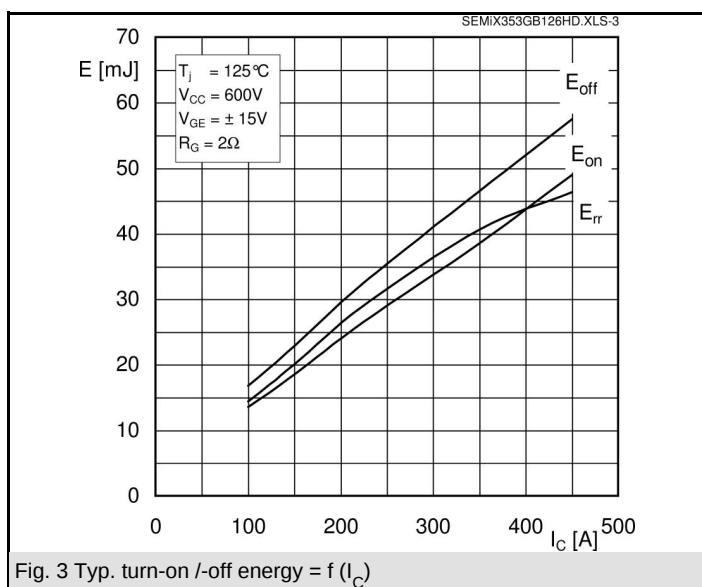
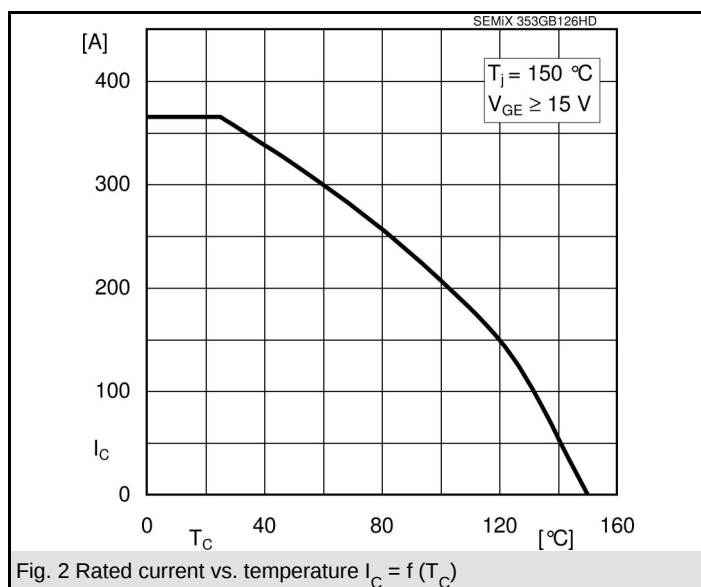
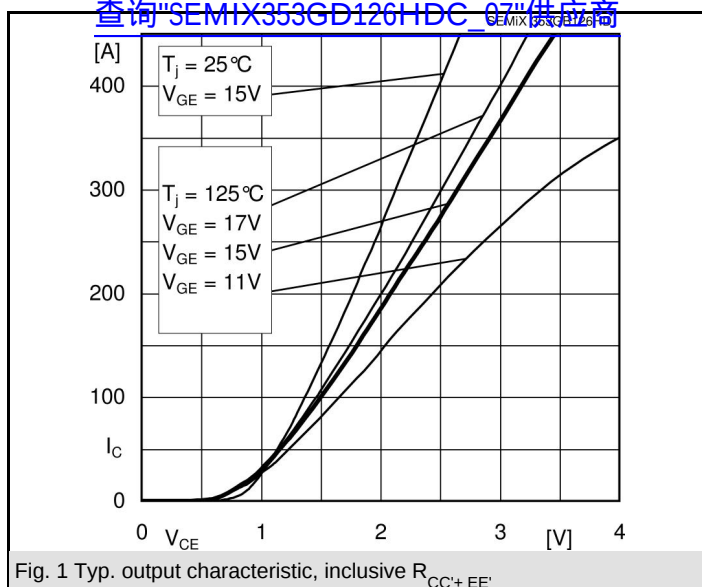
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Characteristics					
Symbol	Conditions		min.	typ.	max. Units
Inverse Diode					
$V_F = V_{EC}$	$I_{Fnom} = 225\text{ A}; V_{GE} = 0\text{ V}$	$T_j = 25\text{ }^{\circ}\text{C}_{chiplev.}$		1,6	1,8 V
		$T_j = 125\text{ }^{\circ}\text{C}_{chiplev.}$		1,6	1,8 V
V_{F0}		$T_j = 25\text{ }^{\circ}\text{C}$		1	1,1 V
		$T_j = 125\text{ }^{\circ}\text{C}$		0,8	0,9 V
r_F		$T_j = 25\text{ }^{\circ}\text{C}$		2,7	3,1 mΩ
		$T_j = 125\text{ }^{\circ}\text{C}$		3,6	4 mΩ
I_{RRM}	$I_{Fnom} = 225\text{ A}$	$T_j = 125\text{ }^{\circ}\text{C}$		330	A
Q_{rr}	$di/dt = 5600\text{ A}/\mu\text{s}$			69	μC
E_{rr}	$V_{GE} = -15\text{ V}; V_{CC} = 600\text{ V}$			29	mJ
$R_{th(j-c)D}$	per diode			0,17	K/W
Module					
L_{CE}				20	nH
$R_{CC'+EE'}$	res., terminal-chip	$T_{case} = 25\text{ }^{\circ}\text{C}$		0,7	mΩ
		$T_{case} = 125\text{ }^{\circ}\text{C}$		1	mΩ
$R_{th(c-s)}$	per module			0,014	K/W
M_s	to heat sink (M5)		3	5	Nm
M_t	to terminals (M6)		2,5	5	Nm
w				900	g
Temperature sensor					
R_{100}	$T_c=100^{\circ}\text{C}$ ($R_{25}=5\text{ k}\Omega$)			0,493±5%	kΩ
$B_{100/125}$	$R(T)=R_{100}\exp[B_{100/125}(1/T-1/T_{100})]$; $T[K]; B$			3550±2%	K

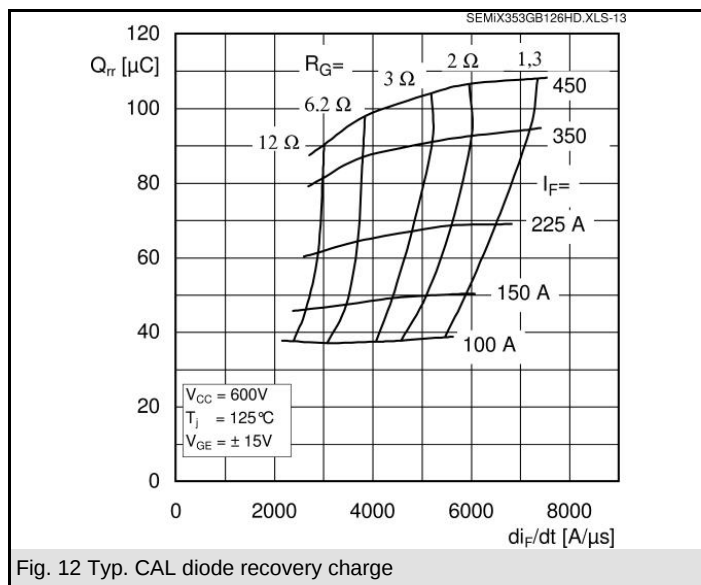
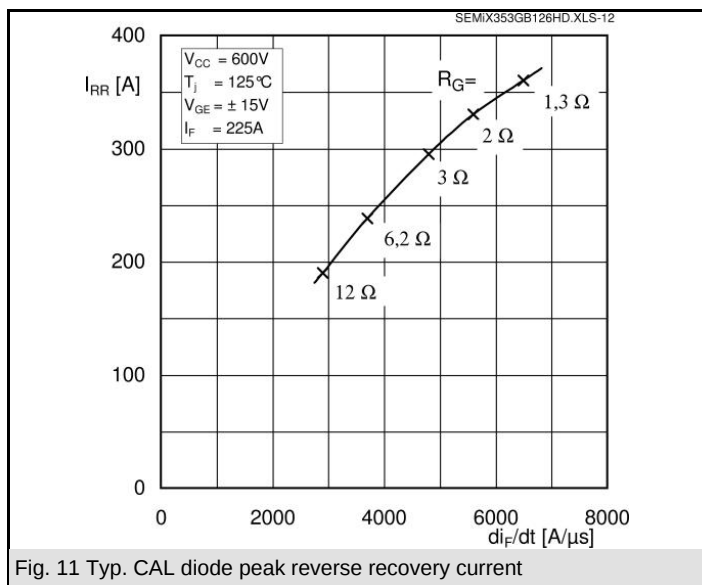
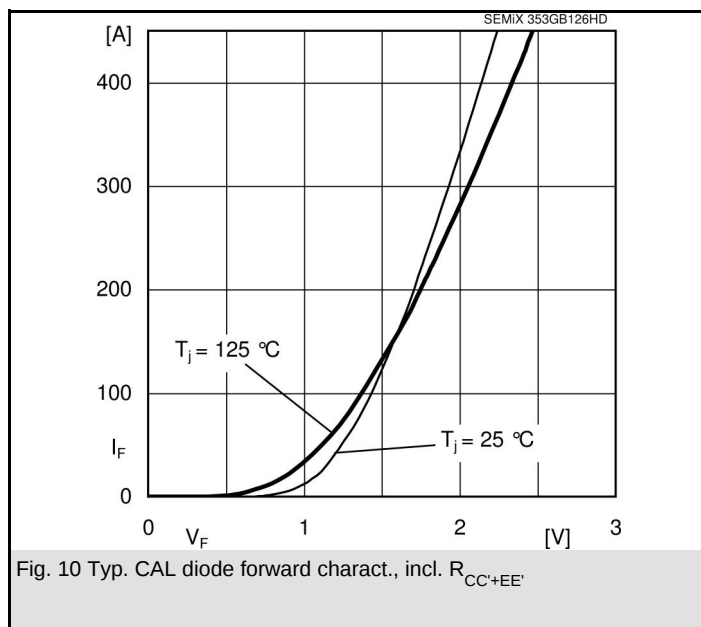
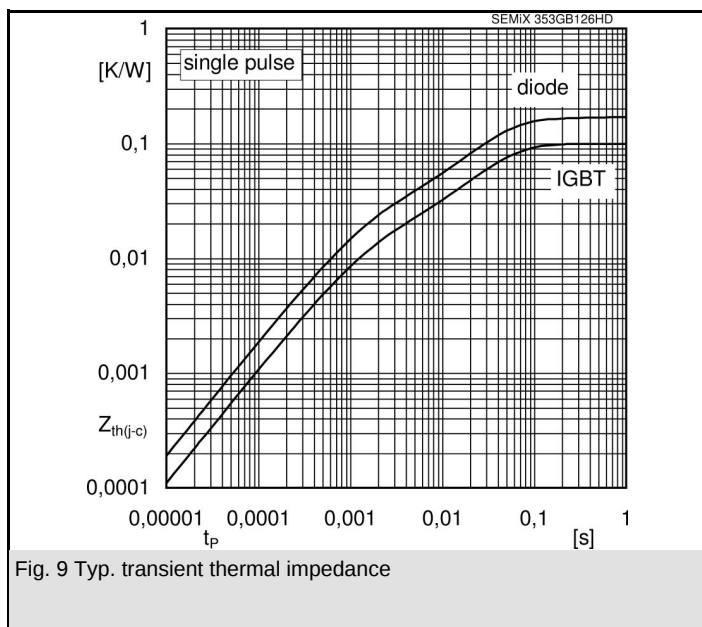
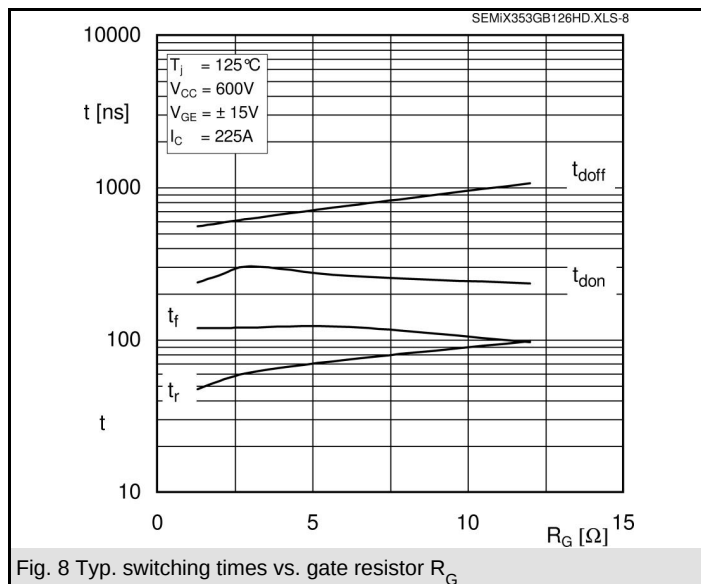
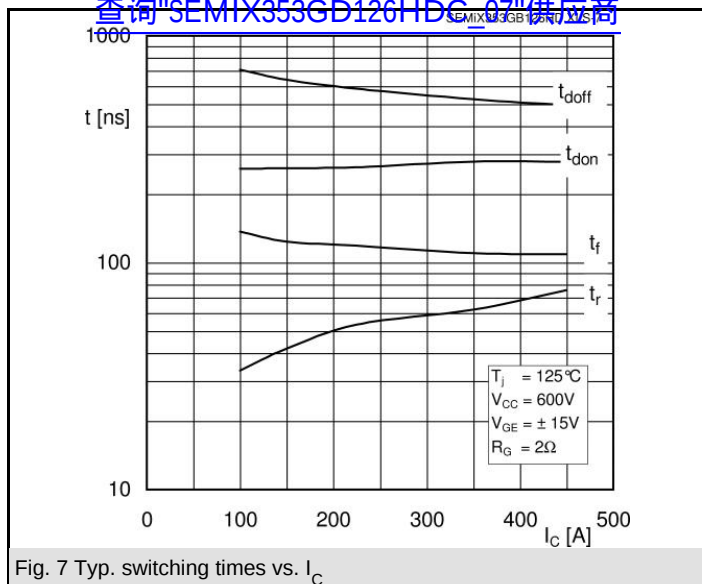
This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee expressed or implied is made regarding delivery, performance or suitability.

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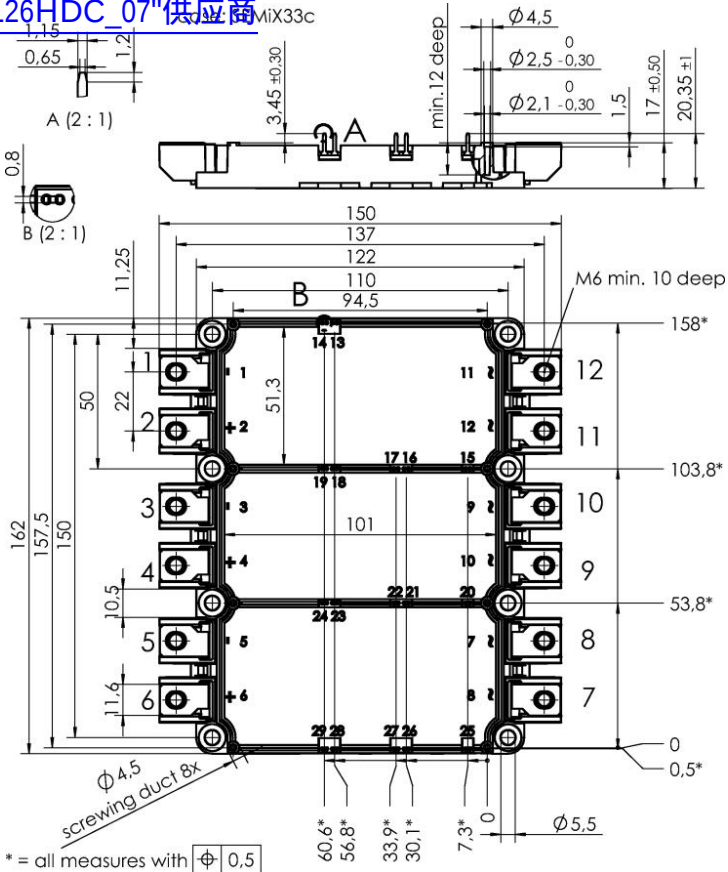


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Case SEMiX 33c

